3rd International Conference on Materials Processing and Characterisation

(ICMPC 2014)

Procedia Materials Science Volume 6

Hyderabad, India
8 – 9 March 2014

Part 1 of 3

Editors:

S. K. Singh

ISBN: 978-1-63439-373-7

Printed from e-media with permission by:

Curran Associates, Inc.
57 Morehouse Lane
Red Hook, NY 12571

Some format issues inherent in the e-media version may also appear in this print version.

Printed by Curran Associates, Inc. (2014)

For permission requests, please contact Elsevier B.V.
at the address below.

Elsevier B.V.
Radarweg 29
Amsterdam 1043 NX
The Netherlands

Phone: +31 20 485 3911
Fax: +31 20 485 2457

http://www.elsevierpublishingsolutions.com/contact.asp

Additional copies of this publication are available from:

Curran Associates, Inc.
57 Morehouse Lane
Red Hook, NY 12571 USA
Phone: 845-758-0400
Fax: 845-758-2634
Email: curran@proceedings.com
Web: www.proceedings.com

TABLE OF CONTENTS

PART 1

PART 2

PART 3